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# CD74HCT4052, CD54/74HC4053, CD54/74HC54053 HIGH-SPEED CMOS LOGIC ANALOG MULTIPLEXERS/DEMULTIPLEXERS

Check for Samples: CD/74HC4051, CD54/74HCT4051, CD54/74HC4052,

#### **FEATURES**

- Wide Analog Input Voltage Range. . ±5 V Max
- Low ON Resistance
  - 70  $\Omega$  Typical (V<sub>CC</sub> V<sub>EE</sub> = 4.5 V)
  - 40  $\Omega$  Typical ( $V_{CC} V_{EE} = 9 V$ )
- Low Crosstalk Between Switches
- Fast Switching and Propagation Speeds
- Break-Before-Make Switching
- Wide Operating Temperature Range –55°C to 125°C
- CD54HC/CD74HC Types
  - Operation Control Voltage . . . . . 2 V to 6 V
  - Switch Voltage . . . . . . . . . . 0 V to 10 V
- CD54HCT/CD74HCT Types
  - Operation Control Voltage . . . 4.5 V to 5.5 V
  - Switch Voltage . . . . . . . . . . 0 V to 10

- Direct LSTTL Input Logic Compatibility
   V<sub>IL</sub> = 0.8 V Max, V<sub>IH</sub> = 2 V Min
- CMOS Input Compatibility  $I_I \le 1 \mu A$  at  $V_{OL}$ ,  $V_{OH}$

#### DESCRIPTION

These devices are digitally controlled analog switches which utilize silicon gate CMOS technology to achieve operating speeds similar to LSTTL with the low power consumption of standard CMOS integrated circuits.

These analog multiplexers/demultiplexers control analog voltages that may vary across the voltage supply range (i.e.,  $V_{CC}$  to  $V_{EE}$ ). They are bidirectional switches thus allowing any analog input to be used as an output and vice-versa. The switches have low ON resistance and low OFF leakages. In addition, all three devices have an enable control which, when high, disables all switches to their OFF state.

#### ORDERING INFORMATION(1)

| PART NUMBER     | TEMP. RANGE<br>(°C) | PACKAGE      |
|-----------------|---------------------|--------------|
| CD54HC4051F3A   | –55 to 125          | 16 Ld CERDIP |
| CD54HC4052F3A   | -55 to 125          | 16 Ld CERDIP |
| CD54HC4053F3A   | -55 to 125          | 16 Ld CERDIP |
| CD54HCT4051F3A  | -55 to 125          | 16 Ld CERDIP |
| CD74HC4051E     | -55 to 125          | 16 Ld PDIP   |
| CD74HC4051M     | -55 to 125          | 16 Ld SOIC   |
| CD74HC4051MT    | -55 to 125          | 16 Ld SOIC   |
| CD74HC4051M96G3 | -55 to 125          | 16 Ld SOIC   |
| CD74HC4051NSR   | -55 to 125          | 16 Ld SOP    |
| CD74HC4051PWR   | -55 to 125          | 16 Ld TSSOP  |
| CD74HC4051PWT   | -55 to 125          | 16 Ld TSSOP  |
| CD74HC4052E     | -55 to 125          | 16 Ld PDIP   |
| CD74HC4052M     | -55 to 125          | 16 Ld SOIC   |
| CD74HC4052MT    | -55 to 125          | 16 Ld SOIC   |
| CD74HC4052M96G3 | -55 to 125          | 16 Ld SOIC   |
| CD74HC4052NSR   | –55 to 125          | 16 Ld SOP    |
| CD74HC4052PW    | -55 to 125          | 16 Ld TSSOP  |
| CD74HC4052PWR   | –55 to 125          | 16 Ld TSSOP  |

<sup>(1)</sup> When ordering, use the entire part number. The suffixes 96 and R denote tape and reel. The suffix T denotes a small-quantity reel of 250.



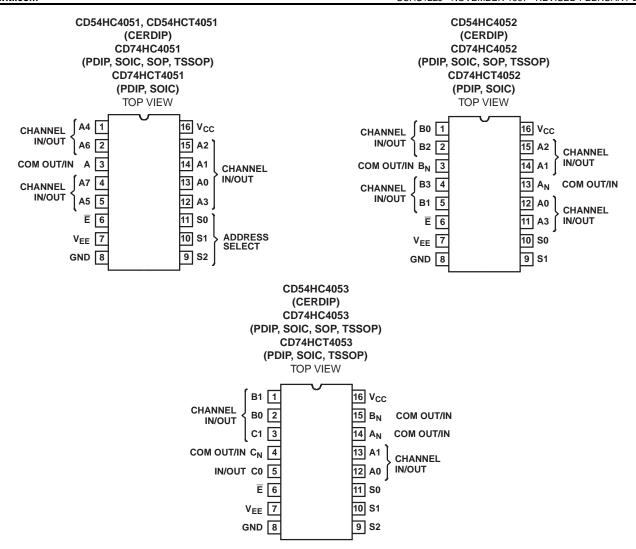
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# ORDERING INFORMATION<sup>(1)</sup> (continued)

| PART NUMBER     | TEMP. RANGE | PACKAGE     |
|-----------------|-------------|-------------|
| PART NUMBER     | (°C)        | PACKAGE     |
| CD74HC4052PWT   | -55 to 125  | 16 Ld TSSOP |
| CD74HC4053E     | -55 to 125  | 16 Ld PDIP  |
| CD74HC4053M     | -55 to 125  | 16 Ld SOIC  |
| CD74HC4053MT    | -55 to 125  | 16 Ld SOIC  |
| CD74HC4053M96G3 | -55 to 125  | 16 Ld SOIC  |
| CD74HC4053NSR   | -55 to 125  | 16 Ld SOP   |
| CD74HC4053PW    | -55 to 125  | 16 Ld TSSOP |
| CD74HC4053PWRG3 | -55 to 125  | 16 Ld TSSOP |
| CD74HC4053PWT   | -55 to 125  | 16 Ld TSSOP |
| CD74HCT4051E    | -55 to 125  | 16 Ld PDIP  |
| CD74HCT4051M    | -55 to 125  | 16 Ld SOIC  |
| CD74HCT4051MT   | -55 to 125  | 16 Ld SOIC  |
| CD74HCT4051M96  | -55 to 125  | 16 Ld SOIC  |
| CD74HCT4052E    | -55 to 125  | 16 Ld PDIP  |
| CD74HCT4052M    | -55 to 125  | 16 Ld SOIC  |
| CD74HCT4052MT   | -55 to 125  | 16 Ld SOIC  |
| CD74HCT4052M96  | -55 to 125  | 16 Ld SOIC  |
| CDHCT4053E      | -55 to 125  | 16 Ld PDIP  |
| CDHCT4053M      | -55 to 125  | 16 Ld SOIC  |
| CDHCT4053MT     | -55 to 125  | 16 Ld SOIC  |
| CDHCT4053M96    | -55 to 125  | 16 Ld SOIC  |
| CDHCT4053PWR    | -55 to 125  | 16 Ld TSSOP |
| CDHCT4053PWT    | -55 to 125  | 16 Ld TSSOP |

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#### **FUNCTIONAL DIAGRAM OF HC/HCT4051**

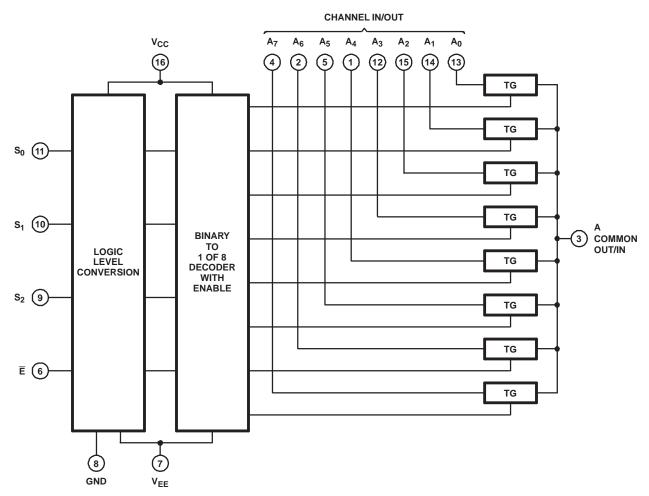


Table 1. TRUTH TABLE 'HC/CD74HCT4051<sup>(1)</sup>

|        | INPUT S        | STATES         |                | ON CHANNELS |
|--------|----------------|----------------|----------------|-------------|
| ENABLE | S <sub>2</sub> | S <sub>1</sub> | S <sub>0</sub> |             |
| L      | L              | L              | L              | A0          |
| L      | L              | L              | Н              | A1          |
| L      | L              | Н              | L              | A2          |
| L      | L              | Н              | Н              | A3          |
| L      | Н              | L              | L              | A4          |
| L      | Н              | L              | Н              | A5          |
| L      | Н              | Н              | L              | A6          |
| L      | Н              | Н              | Н              | A7          |
| Н      | Х              | Х              | Х              | None        |

(1) X = Don't care



#### **FUNCTIONAL DIAGRAM OF HC4052, CD74HCT4052**

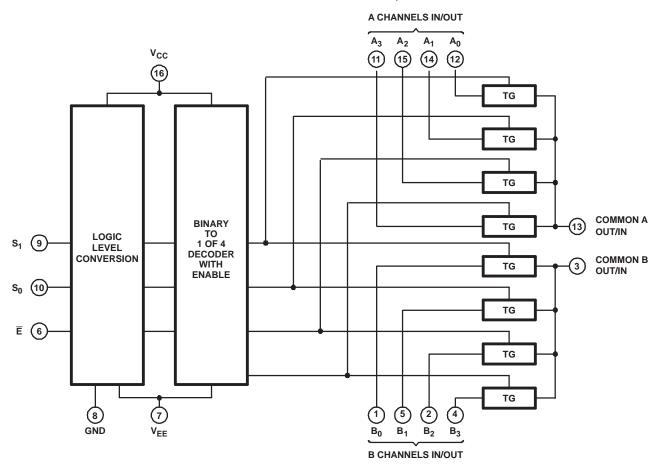


Table 2. FUNCTION TABLE 'HC4052, CD74HCT4052<sup>(1)</sup>

|        | INPUT STATES   |                | ON CHANNELS |
|--------|----------------|----------------|-------------|
| ENABLE | S <sub>1</sub> | S <sub>0</sub> |             |
| L      | L              | L              | A0, B0      |
| L      | L              | Н              | A1, B1      |
| L      | Н              | L              | A2, B2      |
| L      | Н              | Н              | A3, B3      |
| Н      | Х              | X              | None        |

(1) X = Don't care



#### FUNCTIONAL DIAGRAM OF 'HC4053, CD74HCT4053

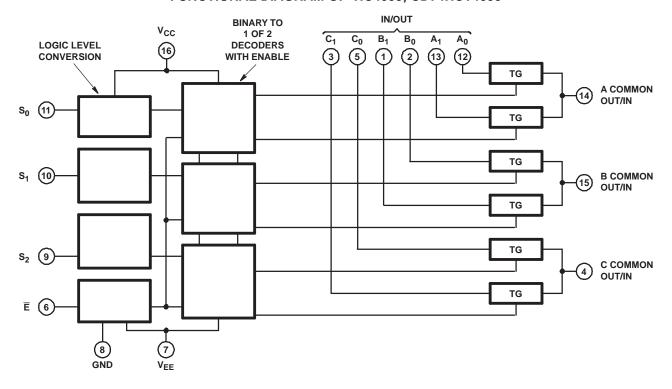


Table 3. FUNCTION TABLE 'HC4053, CD74HCT4053<sup>(1)</sup>

|        | INPUT S        | STATES         |                | ON CHANNELS |
|--------|----------------|----------------|----------------|-------------|
| ENABLE | S <sub>0</sub> | S <sub>1</sub> | S <sub>2</sub> |             |
| L      | L              | L              | L              | C0, B0, A0  |
| L      | Н              | L              | L              | C0, B0, A1  |
| L      | L              | Н              | L              | C0, B1, A0  |
| L      | Н              | Н              | L              | C0, B1, A1  |
| L      | L              | L              | Н              | C1, B0, A0  |
| L      | Н              | L              | Н              | C1, B0, A1  |
| L      | L              | Н              | Н              | C1, B1, A0  |
| L      | Н              | Н              | Н              | C1, B1, A1  |
| Н      | X              | X              | X              | None        |

(1) X = Don't care

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# Absolute Maximum Ratings(1) (2)

over operating free-air temperature range (unless otherwise noted)

|                                   |                                      |   | MIN  | MAX  | UNIT   |
|-----------------------------------|--------------------------------------|---|------|------|--------|
| V <sub>CC</sub> - V <sub>EE</sub> | DC supply voltage                    |   | -0.5 | 10.5 | V      |
| V <sub>CC</sub>                   | DC supply voltage                    |   | -0.5 | 7    | V      |
| V <sub>EE</sub>                   | DC supply voltage                    |   | 0.5  | -7   | V      |
| I <sub>IK</sub>                   | DC input diode current               | $V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$         |      | ±20  | mA     |
| I <sub>OK</sub>                   | DC switch diode current              | $V_{I} < V_{EE} - 0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$ |      | ±20  | mA     |
|                                   | DC switch current                    | $V_{I} > V_{EE} - 0.5 \text{ V or } V_{I} < V_{CC} + 0.5 \text{ V}$ |      | ±25  | mA     |
| I <sub>CC</sub>                   | DC V <sub>CC</sub> or ground current | •   |      | ±50  | mA     |
| I <sub>EE</sub>                   | DC V <sub>EE</sub> current           |   |      | -20  | mA     |
|                                   |                                      | E (PDIP) package  |      | 67   |        |
| 0                                 | Dealtage thermal impedance (3)       | M (SOIC) package  |      | 73   | °C 111 |
| $\theta_{JA}$                     | Package thermal impedance (3)        | NS (SOP) package  |      | 64   | °C/W   |
|                                   |                                      | PW (TSSOP) package  |      | 108  |        |
|                                   | Maximum junction temperature         |   |      | 150  | °C     |
|                                   | Maximum storage temperature rang     | ge  | -65  | 150  | °C     |
|                                   | Maximum lead temperature (solder     | ing 10 s)   |      | 300  | °C     |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### **Recommended Operating Conditions**

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

|                                   | PARAM   | METER  | MIN      | MAX      | UNIT     |
|-----------------------------------|---|--|----------|----------|----------|
| V (1)                             | Supply voltage range  | CD54/74HC types                                  | 2        | 6        | <b>V</b> |
| V <sub>CC</sub> (1)               | $(T_A = full package temperature range)$                                  | CD54/74HCT types                                 | 4.5      | 5.5      | V        |
| V <sub>CC</sub> – V <sub>EE</sub> | Supply voltage range<br>(T <sub>A</sub> = full package temperature range) | CD54/74HC types, CD54/74HCT types (see Figure 1) | 2        | 10       | V        |
| V <sub>EE</sub> (2)               | Supply voltage range<br>(T <sub>A</sub> = full package temperature range) | CD54/74HC types, CD54/74HCT types (see Figure 2) | 0        | -6       | ٧        |
| $V_{I}$                           | DC input control voltage  |  | GND      | $V_{CC}$ | <b>V</b> |
| $V_{IS}$                          | Analog switch I/O voltage   |  | $V_{EE}$ | $V_{CC}$ | V        |
| T <sub>A</sub>                    | Operating temperature   |  | -55      | 125      | °C       |
|                                   |   | 2 V  | 0        | 1000     |          |
| t <sub>r</sub> , t <sub>f</sub>   | Input rise and fall times   | 4.5 V  | 0        | 500      | ns       |
|                                   |   | 6 V  | 0        | 400      |          |

<sup>(1)</sup> All voltages referenced to GND unless otherwise specified.

<sup>(2)</sup> All voltages referenced to GND unless otherwise specified.

<sup>(3)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

<sup>(2)</sup> In certain applications, the external load resistor current may include both V<sub>CC</sub> and signal line components. To avoid drawing V<sub>CC</sub> current when switch current flows into the transmission gate inputs, the voltage drop across the bidirectional switch must not exceed 0.6 V (calculated from r<sub>ON</sub> values shown in Electrical Specifications table). No V<sub>CC</sub> current will flow through R<sub>L</sub> if the switch current flows into terminal 3 on the HC/HCT4051; terminals 3 and 13 on the HC/HCT4052; terminals 4, 14, and 15 on the HC/HCT4053.



# **Recommended Operating Area as a Function of Supply Voltages**

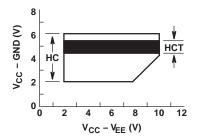


Figure 1.

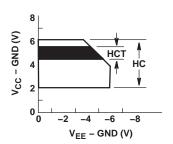


Figure 2.

# **DC Electrical Specifications**

|                     |                          |                                    |  |                                    |                        |                        |      | AME  | BIENT T | EMPER       | ATURE, | T <sub>A</sub> |      |      |
|---------------------|--------------------------|------------------------------------|--|------------------------------------|------------------------|------------------------|------|------|---------|-------------|--------|----------------|------|------|
|                     | PARAMETER                |                                    | TE   | ST CONDITIO                        | ONS                    |                        |      | 25°C |         | –40°<br>85° |        | –55°(<br>125   |      | UNIT |
|                     |                          |                                    | V <sub>IS</sub> (V)                                | V <sub>I</sub><br>(V)              | V <sub>EE</sub><br>(V) | V <sub>CC</sub><br>(V) | MIN  | TYP  | MAX     | MIN         | MAX    | MIN            | MAX  |      |
| НС Ту               | pes                      |                                    |  | ,                                  |                        |                        | •    |      | •       |             | ·      |                |      |      |
|                     |                          |                                    |  |                                    |                        | 2                      | 1.5  |      |         | 1.5         |        | 1.5            |      |      |
| $V_{IH}$            | High-level input v       | oltage                             |  |                                    |                        | 4.5                    | 3.15 |      |         | 3.15        |        | 3.15           | 0    | V    |
|                     |                          |                                    |  |                                    |                        | 6                      | 4.2  |      |         | 4.2         |        | 4.2            |      |      |
|                     |                          |                                    |  |                                    |                        | 2                      |      |      | 0.5     |             | 0.5    |                | 0.5  |      |
| $V_{IL}$            | Low-level input vo       | oltage                             |  |                                    |                        | 4.5                    |      |      | 1.35    |             | 1.35   |                | 1.35 | V    |
|                     |                          | 1                                  |  |                                    |                        | 6                      |      |      | 1.8     |             | 1.8    |                | 1.8  |      |
|                     |                          |                                    |  |                                    | 0                      | 4.5                    |      | 70   | 160     |             | 200    |                | 240  |      |
|                     |                          |                                    | V <sub>CC</sub> or V <sub>EE</sub>                 |                                    | 0                      | 6                      |      | 60   | 140     |             | 175    |                | 210  |      |
| r <sub>ON</sub>     | ON resistance            | I <sub>O</sub> = 1 mA<br>(see      |  | V <sub>IL</sub> or V <sub>IH</sub> | -4.5                   | 4.5                    |      | 40   | 120     |             | 150    |                | 180  | Ω    |
| ON STATISSISSISSISS | Figure 11)               |                                    | 1 L 0. 1 H   | 0                                  | 4.5                    |                        | 90   | 180  |         | 225         |        | 270            |      |      |
|                     |                          | V <sub>CC</sub> to V <sub>EE</sub> |  | 0                                  | 6                      |                        | 80   | 160  |         | 200         |        | 240            |      |      |
|                     |                          |                                    |  |                                    | -4.5                   | 4.5                    |      | 45   | 130     |             | 162    |                | 195  |      |
|                     | Maximum ON res           | intonno                            |  |                                    | 0                      | 4.5                    |      | 10   |         |             |        |                |      |      |
| $\Delta r_{ON}$     | between any two          |                                    |  |                                    | 0                      | 6                      |      | 8.5  |         |             |        |                |      | Ω    |
|                     |                          | 1                                  |  |                                    | -4.5                   | 4.5                    |      | 5    |         |             |        |                |      |      |
|                     |                          | 1 and 2 channels                   | For switch OFF:<br>When $V_{IS} = V_{CC}$ ,        |                                    | 0                      | 6                      |      |      | ±0.1    |             | ±1     |                | ±1   |      |
|                     |                          | 4053                               | $V_{OS} = V_{EE}$ ,<br>When $V_{IS} = V_{EE}$ ,    |                                    | <b>-</b> 5             | 5                      |      |      | ±0.1    |             | ±1     |                | ±1   |      |
| l <sub>IZ</sub>     | Switch ON/OFF<br>leakage | 4 channels                         | $V_{OS} = V_{CC}$                                  | V <sub>IL</sub> or V <sub>IH</sub> | 0                      | 6                      |      |      | ±0.1    |             | ±1     |                | ±1   | μA   |
| ız                  | current                  | 4052                               | For switch ON:<br>All applicable                   | 12 111                             | <b>-</b> 5             | 5                      |      |      | ±0.2    |             | ±2     |                | ±2   |      |
|                     |                          | 8 channels                         | combinations of                                    |                                    | 0                      | 6                      |      |      | ±0.2    |             | ±2     |                | ±2   |      |
|                     |                          | 4051                               | V <sub>IS</sub> and V <sub>OS</sub> voltage levels |                                    | <b>-</b> 5             | 5                      |      |      | ±0.4    |             | ±4     |                | ±4   |      |
| I <sub>IL</sub>     | Control input leak       | age current                        |  | V <sub>CC</sub> or<br>GND          | 0                      | 6                      |      |      | ±0.1    |             | ±1     |                | ±1   | μΑ   |
|                     | Quiescent                |                                    | When $V_{IS} = V_{EE}$ , $V_{OS} = V_{CC}$         | V <sub>CC</sub> or                 | 0                      | 6                      |      |      | 8       |             | 80     |                | 160  | μΑ   |
| I <sub>CC</sub>     | device<br>current        | I <sub>O</sub> = 0                 | When $V_{IS} = V_{CC}$ , $V_{OS} = V_{EE}$         | GND                                | -5                     | 5                      |      |      | 16      |             | 160    |                | 320  | μA   |

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# **DC Electrical Specifications (Continued)**

|                      |  |                  |   |                       |                        |                        |     | AMI  | SIENT T | EMPER       | ATURE, | $T_A$        |     | Ī    |    |
|----------------------|--|------------------|---|-----------------------|------------------------|------------------------|-----|------|---------|-------------|--------|--------------|-----|------|----|
|                      | PARAMETE   | R                | TEST  | CONDITI               | ONS                    |                        |     | 25°C |         | –40°<br>85° |        | –55°(<br>125 |     | UNIT |    |
|                      |  |                  | V <sub>IS</sub> (V)   | V <sub>1</sub><br>(V) | V <sub>EE</sub><br>(V) | V <sub>cc</sub><br>(V) | MIN | TYP  | MAX     | MIN         | MAX    | MIN          | MAX |      |    |
| НСТ Ту               | pes  |                  |   |                       |                        |                        |     |      |         |             |        |              |     |      |    |
| V <sub>IH</sub>      | High-level input v                                     | oltage           |   |                       |                        | 4.5 to<br>5.5          | 2   |      |         | 2           |        | 2            |     | V    |    |
| V <sub>IL</sub>      | Low-level input vo                                     | oltage           |   |                       |                        | 4.5 to<br>5.5          |     |      | 0.8     |             | 0.8    |              | 0.8 | V    |    |
|                      |  |                  |   |                       | 0                      | 4.5                    |     | 70   | 160     |             | 200    |              | 240 |      |    |
|                      |  |                  | V <sub>CC</sub> or V <sub>EE</sub>                          |                       |                        |                        |     |      |         |             |        |              |     |      |    |
| F                    | ON resistance   I <sub>O</sub> = 1 m                   |                  |   | V <sub>IL</sub> or    | -4.5                   | 4.5                    |     | 40   | 120     |             | 150    |              | 180 | Ω    |    |
| r <sub>ON</sub>      | Figure 15)   |                  |   | V <sub>IH</sub>       | 0                      | 4.5                    |     | 90   | 180     |             | 225    |              | 270 | . 12 |    |
|                      |  |                  | $V_{CC}$ to $V_{EE}$  |                       |                        |                        |     |      |         |             |        |              |     |      |    |
|                      |  |                  |   |                       | -4.5                   | 4.5                    |     | 45   | 130     |             | 162    |              | 195 |      |    |
|                      | Maximum ON res   | intanaa          |   |                       | 0                      | 4.5                    |     | 10   |         |             |        |              |     |      |    |
| $\Delta r_{ON}$      | between any two  |                  |   |                       |                        |                        |     |      |         |             |        |              |     | Ω    |    |
|                      |  |                  |   |                       | -4.5                   | 4.5                    |     | 5    |         |             |        |              |     |      |    |
|                      |  | 1 and 2 channels | For switch OFF:<br>When V <sub>IS</sub> = V <sub>CC</sub> , |                       | 0                      | 6                      |     |      | ±0.1    |             | ±1     |              | ±1  |      |    |
|                      |  | 4053             | $V_{OS} = V_{EE},$ When $V_{IS} = V_{EE},$                  |                       | <b>–</b> 5             | 5                      |     |      | ±0.1    |             | ±1     |              | ±1  |      |    |
| I <sub>IZ</sub>      | Switch ON/OFF  | 4 channels       | $V_{OS} = V_{CC}$   | V <sub>IL</sub> or    | 0                      | 6                      |     |      | ±0.1    |             | ±1     |              | ±1  | μΑ   |    |
|                      | leakage current  | 4052             | For switch ON: All applicable                               | V <sub>IH</sub>       | <b>–</b> 5             | 5                      |     |      | ±0.2    |             | ±2     |              | ±2  |      |    |
|                      |  | 8 channels       | combinations of   |                       | 0                      | 6                      |     |      | ±0.2    |             | ±2     |              | ±2  |      |    |
|                      |  | 4051             | V <sub>IS</sub> and V <sub>OS</sub> voltage levels          |                       | <b>-</b> 5             | 5                      |     |      | ±0.4    |             | ±4     |              | ±4  |      |    |
| I <sub>IL</sub>      | Control input leak                                     | age current      |   | (1)                   |                        | 5.5                    |     |      | ±0.1    |             | ±1     |              | ±1  | μA   |    |
|                      | Quiescent  |                  | When $V_{IS} = V_{EE}$ , $V_{OS} = V_{CC}$                  | V <sub>CC</sub> or    | 0                      | 5.5                    |     |      | 8       |             | 80     |              | 160 | μΑ   |    |
| СС                   | device<br>current                                      | 0 -              | $I_O = 0$ When $V_{IS} = V_{CC}$ , $V_{OS} = V_{EE}$        |                       | ĞŇD                    | -4.5                   | 5.5 |      |         | 16          |        | 160          |     | 320  | μΑ |
| ΔI <sub>CC</sub> (2) | Additional quiesco<br>device current pe<br>1 unit load |                  | $\Delta I_{CC}^{(2)}$                                       | V <sub>CC</sub> – 2.1 |                        | 4.5 to<br>5.5          |     | 100  | 360     |             | 450    |              | 490 | μΑ   |    |

<sup>(1)</sup> Any voltage between  $V_{CC}$  and GND (2) For dual-supply systems, theoretical worst-case ( $V_I = 2.4 \text{ V}$ ,  $V_{CC} = 5.5 \text{ V}$ ) specification is 1.8 mA.



#### **Table 4. HCT INPUT LOADING TABLE**

| TYPE       | INPUT | UNIT LOADS <sup>(1)</sup> |
|------------|-------|---------------------------|
| 4051, 4053 | All   | 0.5                       |
| 4052       | All   | 0.4                       |

(1) Unit load is  $\Delta I_{CC}$  limit specified in DC Specifications table, e.g., 360 mA MAX at 25°C.

#### **Switching Specifications**

 $V_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}, \text{ input } t_r, t_f = 6 \text{ ns}$ 

|                                     |                               |                          |            |      |     | TYP  | ICAL |      |     |      |
|-------------------------------------|-------------------------------|--------------------------|------------|------|-----|------|------|------|-----|------|
|                                     | PARAMETER                     | TEST CONDITIONS          | CL<br>(pF) | 4051 |     | 4052 |      | 4053 |     | UNIT |
|                                     |                               |                          | (рі)       | НС   | НСТ | НС   | нст  | НС   | нст |      |
| t <sub>PHL</sub> , t <sub>PLH</sub> |                               | Switch IN to OUT         | 15         | 4    | 4   | 4    | 4    | 4    | 4   |      |
| t <sub>PHZ</sub> , t <sub>PLZ</sub> | Propagation delay             | Switch turn-off (S or E) | 15         | 19   | 19  | 21   | 21   | 18   | 18  | ns   |
| t <sub>PZH</sub> , t <sub>PZL</sub> |                               | Switch turn-on (S or E)  | 15         | 19   | 23  | 27   | 29   | 18   | 20  |      |
| C <sub>PD</sub> (1)                 | Power dissipation capacitance |                          |            | 50   | 52  | 74   | 76   | 38   | 42  | pF   |

(1)  $C_{PD}$  is used to determine the dynamic power consumption, per package.  $P_D = C_{PD} \ V_{CC} \ ^2 f_I + \sum (C_L + C_S) \ V_{CC} \ ^2 f_O$   $f_O =$  output frequency

 $f_l$  = input frequency  $C_L$  = output load capacitance

 $C_S$  = switch capacitance

 $V_{CC}$  = supply voltage

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# **Switching Specifications**

 $C_L = 50 \text{ pF}$ , input  $t_r$ ,  $t_f = 6 \text{ ns}$ 

|                    |  |      |      |                 |         |     | - 1 |     |         | PERATI | JRE, T <sub>A</sub> |                |     |     |     | 1    |
|--------------------|--|------|------|-----------------|---------|-----|-----|-----|---------|--------|---------------------|----------------|-----|-----|-----|------|
|                    | PARAMETER  |      | VEE  | V <sub>cc</sub> | 2       | 5°C |     |     | –40°C t | o 85°C |                     | –55°C to 125°C |     |     |     | UNIT |
|                    | T A COUNTER CONTRACTOR                             |      | (V)  | (V)             | HC      | Н   | CT  | Н   | С       | НС     | T                   | Н              | С   | НС  | CT  |      |
|                    |  |      |      |                 | MIN MAX | MIN | MAX | MIN | MAX     | MIN    | MAX                 | MIN            | MAX | MIN | MAX |      |
|                    |  |      | 0    | 2               | 60      |     |     |     | 75      |        |                     |                | 90  |     |     |      |
| t <sub>PLH</sub> , | Propagation delay,                                 |      | 0    | 4.5 12 12       |         | 15  |     | 15  |         | 18     |                     | 18             | ns  |     |     |      |
| t <sub>PHL</sub>   | switch in to out                                   |      | 0    | 6               | 10      |     |     |     | 13      |        |                     |                | 15  |     |     | 113  |
|                    |  |      | -4.5 | 4.5             | 8       |     | 8   |     | 10      |        | 10                  |                | 12  |     | 12  |      |
|                    |  |      | 0    | 2               | 225     |     |     |     | 280     |        |                     |                | 340 |     |     |      |
|                    |  | 4051 | 0    | 4.5             | 45      |     | 45  |     | 56      |        | 56                  |                | 68  |     | 68  |      |
|                    |  | 4031 | 0    | 6               | 38      |     |     |     | 48      |        |                     |                | 57  |     |     | -    |
|                    |  |      | -4.5 | 4.5             | 32      |     | 32  |     | 40      |        | 40                  |                | 48  |     | 48  |      |
|                    |  |      | 0    | 2               | 250     |     |     |     | 315     |        |                     |                | 375 |     |     |      |
| t <sub>PHZ</sub> , | Maximum switch turn $\overline{E}$ to              | 4052 | 0    | 4.5             | 50      |     | 50  |     | 63      |        | 63                  |                | 75  |     | 75  |      |
| t <sub>PLZ</sub>   | switch output                                      | 4052 | 0    | 6               | 43      |     |     |     | 54      |        |                     |                | 65  |     |     | ns   |
|                    |  |      | -4.5 | 4.5             | 38      |     | 38  |     | 48      |        | 48                  |                | 57  |     | 57  |      |
|                    |  |      | 0    | 2               | 210     |     |     |     | 265     |        |                     |                | 315 |     |     |      |
|                    |  | 4053 | 0    | 4.5             | 42      |     | 44  |     | 53      |        | 55                  |                | 63  |     | 66  |      |
|                    |  | 4053 | 0    | 6               | 36      |     |     |     | 45      |        |                     |                | 54  |     |     |      |
|                    |  |      | -4.5 | 4.5             | 29      |     | 31  |     | 36      |        | 39                  |                | 44  |     | 47  |      |
|                    |  |      | 0    | 2               | 225     |     |     |     | 280     |        |                     |                | 340 |     |     |      |
|                    |  | 1051 | 0    | 4.5             | 45      |     | 55  |     | 56      |        | 69                  |                | 68  |     | 83  |      |
|                    |  | 4051 | 0    | 6               | 38      |     |     |     | 48      |        |                     |                | 57  |     |     |      |
|                    |  |      | -4.5 | 4.5             | 32      |     | 39  |     | 40      |        | 49                  |                | 48  |     | 59  |      |
|                    |  |      | 0    | 2               | 325     |     |     |     | 405     |        |                     |                | 490 |     |     |      |
| $t_{PZL}$ ,        | Maximum switch turn                                | 4050 | 0    | 4.5             | 65      |     | 70  |     | 81      |        | 68                  |                | 98  |     | 105 |      |
| t <sub>PZH</sub>   | ON delay from S or $\overline{E}$ to switch output | 4052 | 0    | 6               | 55      |     |     |     | 69      |        |                     |                | 83  |     |     | n    |
|                    | ,  |      | -4.5 | 4.5             | 46      |     | 48  |     | 58      |        | 60                  |                | 69  |     | 72  |      |
|                    |  |      | 0    | 2               | 220     |     |     |     | 275     |        |                     |                | 330 |     |     |      |
|                    |  | 40=0 | 0    | 4.5             | 44      |     | 48  |     | 55      |        | 60                  |                | 66  |     | 72  |      |
|                    |  | 4053 | 0    | 6               | 37      |     |     |     | 47      |        |                     |                | 56  |     |     |      |
|                    |  |      | -4.5 | 4.5             | 31      |     | 34  |     | 39      |        | 43                  |                | 47  |     | 51  |      |
| Cı                 | Input (control)<br>capacitance                     |      |      |                 | 10      |     | 10  |     | 10      |        | 10                  |                | 10  |     | 10  | pf   |



# **Analog Channel Specifications**

Typical values at  $T_A = 25^{\circ}C$ 

|                        | PARAMETER                                  | TEST CONDITIONS                 | HC/HCT TYPES | V <sub>EE</sub><br>(V) | V <sub>CC</sub><br>(V) | нс/нст | UNIT  |
|------------------------|--|---------------------------------|--------------|------------------------|------------------------|--------|-------|
| Cı                     | Switch input capacitance                   |                                 | All          |                        |                        | 5      | pF    |
|                        |  |                                 | 4051         |                        |                        | 25     |       |
| $C_{COM}$              | Common output capacitance                  |                                 | 4052         |                        |                        | 12     | pF    |
|                        |  |                                 | 4053         |                        |                        | 8      |       |
|                        |  |                                 | 4051         |                        |                        | 145    |       |
|                        |  |                                 | 4052         | -2.25                  | 2.25                   | 165    |       |
| 4                      | Minimum switch frequency response at –3 dB | See Figure 3 (1) (2)            | 4053         |                        |                        | 200    | MHz   |
|                        | (see Figures 12, 14, 16)                   | See Figure 3 (7)                | 4051         |                        |                        | 180    | IVITZ |
|                        |  |                                 | 4052         | -4.5                   | 4.5                    | 185    | _     |
|                        |  |                                 | 4053         |                        |                        | 200    |       |
|                        | Sine-wave distortion                       | Soo Figure F                    | All          | -2.25                  | 2.25                   | 0.035  | %     |
|                        | Sine-wave distortion                       | See Figure 5                    | All          | -4.5                   | 4.5                    | 0.018  | %     |
|                        |  |                                 | 4051         | -2.25                  | 2.25                   | -73    |       |
|                        |  |                                 | 4052         |                        |                        | -65    |       |
| Switch OFF signal feed | Switch OFF signal feedthrough              | See Figure 7 <sup>(2)</sup> (3) | 4053         |                        |                        | -64    | dB    |
|                        | (see Figures 13, 15, 17)                   | See rigule 1 -7 (8)             | 4051         | -4.5                   | 4.5                    | -75    | uB    |
|                        |  |                                 | 4052         |                        |                        | -67    |       |
|                        |  |                                 | 4053         |                        |                        | -66    |       |

Adjust input voltage to obtain 0 dBm at  $V_{OS}$  for  $f_{IN}$  = 1 MHz  $V_{IS}$  is centered at  $(V_{CC} - V_{EE})/2$ . Adjust input for 0 dBm



#### APPLICATION INFORMATION

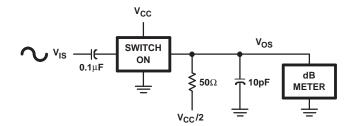


Figure 3. Frequency Response Test Circuit

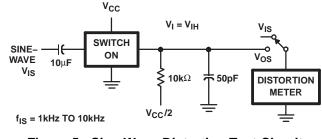
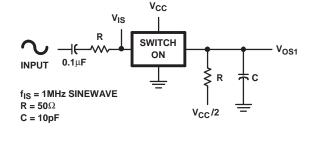
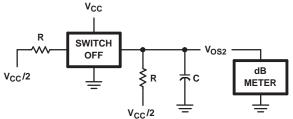


Figure 5. Sine-Wave Distortion Test Circuit





V<sub>CC</sub>/2 Figure 4. Crosstalk Between Two Switches **Test Circuit** 

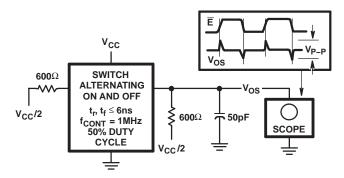


Figure 6. Control to Switch Feedthrough Noise **Test Circuit** 

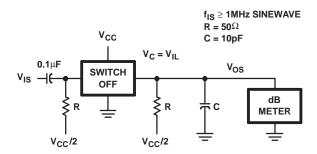


Figure 7. Switch OFF Signal Feedthrough



#### **APPLICATION INFORMATION**

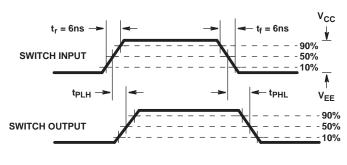


FIGURE 8A.

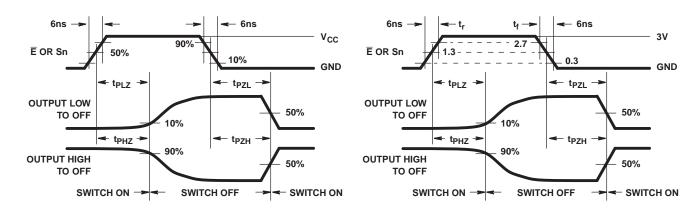


FIGURE 8B. HC TYPES

FIGURE 8C. HCT TYPES

Figure 8. Switch Propagation Delay, Turn-On, Turn-Off Times

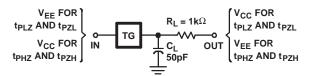


Figure 9. Switch ON/OFF Propagation Delay Test Circuit

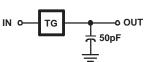


Figure 10. Switch In to Switch Out Propagation Delay Test Circuit



#### TYPICAL PERFORMANCE CURVES

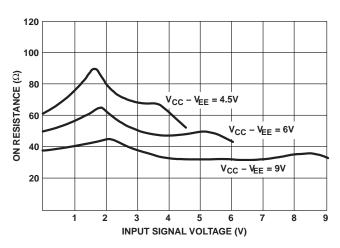


Figure 11. Typical ON Resistance vs Input Signal Voltage

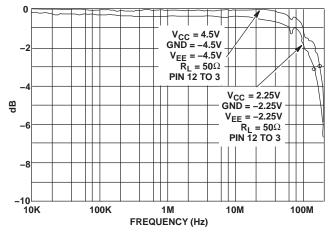


Figure 12. Channel ON Bandwidth (HC/HCT4051)

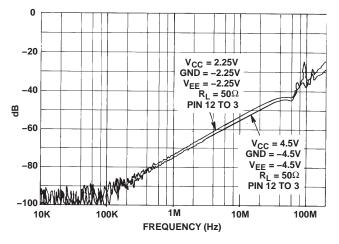


Figure 13. Channel OFF Feedthrough (HC/HCT4051)

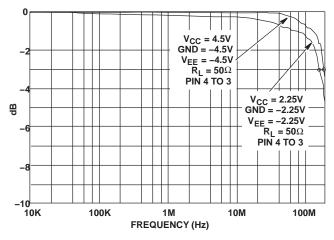


Figure 14. Channel ON Bandwidth (HC/HCT4052)

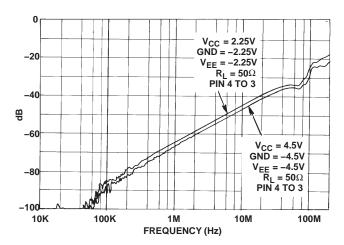


Figure 15. Channel OFF Feedthrough (HC/HCT4052)

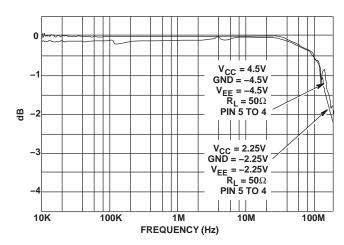


Figure 16. Channel ON Bandwidth (HC/HCT4053)



#### **TYPICAL PERFORMANCE CURVES**

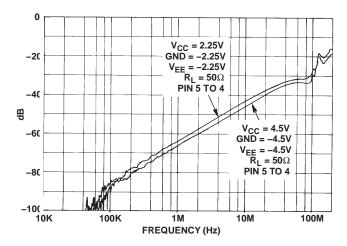


Figure 17. Channel OFF Feedthrough (HC/HCT4053)





22-Jul-2014

#### **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type |         | Pins |      | Eco Plan                   | Lead/Ball Finish  | MSL Peak Temp      | Op Temp (°C) | Device Marking                        | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|-------------------|--------------------|--------------|---------------------------------------|---------|
|                  | (1)    |              | Drawing |      | Qty  | (2)                        | (6)               | (3)                |              | (4/5)                                 |         |
| 5962-8775401EA   | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 5962-8775401EA<br>CD54HC4053F3A       | Samples |
| 5962-8855601EA   | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 5962-8855601EA<br>CD54HC4052F3A       | Samples |
| 5962-9065401MEA  | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 5962-9065401ME<br>A<br>CD54HCT4051F3A | Samples |
| CD54HC4051F      | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | CD54HC4051F                           | Samples |
| CD54HC4051F3A    | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | CD54HC4051F3A                         | Samples |
| CD54HC4052F      | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | CD54HC4052F                           | Samples |
| CD54HC4052F3A    | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 5962-8855601EA<br>CD54HC4052F3A       | Samples |
| CD54HC4053F      | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | CD54HC4053F                           | Samples |
| CD54HC4053F3A    | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 5962-8775401EA<br>CD54HC4053F3A       | Samples |
| CD54HCT4051F3A   | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 5962-9065401ME<br>A<br>CD54HCT4051F3A | Samples |
| CD74HC4051E      | ACTIVE | PDIP         | N       | 16   | 25   | Pb-Free<br>(RoHS)          | CU NIPDAU         | N / A for Pkg Type | -55 to 125   | CD74HC4051E                           | Samples |
| CD74HC4051EE4    | ACTIVE | PDIP         | N       | 16   | 25   | Pb-Free<br>(RoHS)          | CU NIPDAU         | N / A for Pkg Type | -55 to 125   | CD74HC4051E                           | Samples |
| CD74HC4051M      | ACTIVE | SOIC         | D       | 16   | 40   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HC4051M                               | Samples |
| CD74HC4051M96    | ACTIVE | SOIC         | D       | 16   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN | Level-1-260C-UNLIM | -55 to 125   | HC4051M                               | Samples |
| CD74HC4051M96E4  | ACTIVE | SOIC         | D       | 16   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HC4051M                               | Samples |
| CD74HC4051M96G3  | ACTIVE | SOIC         | D       | 16   | 2500 | Green (RoHS<br>& no Sb/Br) | CU SN             | Level-1-260C-UNLIM | -55 to 125   | HC4051M                               | Samples |
| CD74HC4051M96G4  | ACTIVE | SOIC         | D       | 16   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HC4051M                               | Samples |



| Orderable Device | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish (6) | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|----------------------------|----------------------|--------------------|--------------|----------------------|---------|
| CD74HC4051ME4    | ACTIVE     | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4051M              | Samples |
| CD74HC4051MG4    | ACTIVE     | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4051M              | Samples |
| CD74HC4051MT     | ACTIVE     | SOIC         | D                  | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4051M              | Samples |
| CD74HC4051NSR    | ACTIVE     | so           | NS                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4051M              | Samples |
| CD74HC4051NSRE4  | ACTIVE     | so           | NS                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4051M              | Samples |
| CD74HC4051PWR    | ACTIVE     | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN    | Level-1-260C-UNLIM | -55 to 125   | HJ4051               | Samples |
| CD74HC4051PWRG4  | ACTIVE     | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4051               | Samples |
| CD74HC4051PWT    | ACTIVE     | TSSOP        | PW                 | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4051               | Samples |
| CD74HC4051PWTG4  | ACTIVE     | TSSOP        | PW                 | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4051               | Samples |
| CD74HC4052E      | ACTIVE     | PDIP         | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type | -55 to 125   | CD74HC4052E          | Samples |
| CD74HC4052EE4    | ACTIVE     | PDIP         | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type | -55 to 125   | CD74HC4052E          | Samples |
| CD74HC4052M      | ACTIVE     | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4052M              | Samples |
| CD74HC4052M96    | ACTIVE     | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN    | Level-1-260C-UNLIM | -55 to 125   | HC4052M              | Samples |
| CD74HC4052M96E4  | ACTIVE     | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4052M              | Samples |
| CD74HC4052M96G4  | ACTIVE     | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4052M              | Samples |
| CD74HC4052ME4    | ACTIVE     | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4052M              | Samples |
| CD74HC4052MG4    | ACTIVE     | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4052M              | Samples |
| CD74HC4052MT     | ACTIVE     | SOIC         | D                  | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4052M              | Samples |



| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish (6) | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samp |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|----------------------|--------------------|--------------|-------------------------|------|
| CD74HC4052MTG4   | ACTIVE | SOIC         | D                  | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4052M                 | Samp |
| CD74HC4052NSR    | ACTIVE | SO           | NS                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4052M                 | Samp |
| CD74HC4052NSRG4  | ACTIVE | SO           | NS                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4052M                 | Samp |
| CD74HC4052PW     | ACTIVE | TSSOP        | PW                 | 16   | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4052                  | Samp |
| CD74HC4052PWG4   | ACTIVE | TSSOP        | PW                 | 16   | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4052                  | Samp |
| CD74HC4052PWR    | ACTIVE | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN    | Level-1-260C-UNLIM | -55 to 125   | HJ4052                  | Samp |
| CD74HC4052PWRE4  | ACTIVE | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4052                  | Sam  |
| CD74HC4052PWRG4  | ACTIVE | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4052                  | Sam  |
| CD74HC4052PWT    | ACTIVE | TSSOP        | PW                 | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4052                  | Sam  |
| CD74HC4053E      | ACTIVE | PDIP         | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type | -55 to 125   | CD74HC4053E             | Sam  |
| CD74HC4053EE4    | ACTIVE | PDIP         | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type | -55 to 125   | CD74HC4053E             | Sam  |
| CD74HC4053M      | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4053M                 | Sam  |
| CD74HC4053M96    | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN    | Level-1-260C-UNLIM | -55 to 125   | HC4053M                 | Sam  |
| CD74HC4053M96E4  | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4053M                 | Sam  |
| CD74HC4053M96G3  | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU SN                | Level-1-260C-UNLIM | -55 to 125   | HC4053M                 | Sam  |
| CD74HC4053M96G4  | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4053M                 | Sam  |
| CD74HC4053ME4    | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4053M                 | Sam  |
| CD74HC4053MG4    | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4053M                 | Sam  |



| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish (6) | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|----------------------|--------------------|--------------|----------------------|---------|
| CD74HC4053MT     | ACTIVE | SOIC         | D                  | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4053M              | Samples |
| CD74HC4053NSR    | ACTIVE | SO           | NS                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HC4053M              | Samples |
| CD74HC4053PW     | ACTIVE | TSSOP        | PW                 | 16   | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4053               | Samples |
| CD74HC4053PWG4   | ACTIVE | TSSOP        | PW                 | 16   | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4053               | Samples |
| CD74HC4053PWR    | ACTIVE | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN    | Level-1-260C-UNLIM | -55 to 125   | HJ4053               | Samples |
| CD74HC4053PWRG4  | ACTIVE | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4053               | Samples |
| CD74HC4053PWT    | ACTIVE | TSSOP        | PW                 | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HJ4053               | Samples |
| CD74HCT4051E     | ACTIVE | PDIP         | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type | -55 to 125   | CD74HCT4051E         | Samples |
| CD74HCT4051M     | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HCT4051M             | Samples |
| CD74HCT4051M96   | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HCT4051M             | Samples |
| CD74HCT4051M96E4 | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HCT4051M             | Samples |
| CD74HCT4051M96G4 | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HCT4051M             | Samples |
| CD74HCT4051ME4   | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HCT4051M             | Samples |
| CD74HCT4051MG4   | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HCT4051M             | Samples |
| CD74HCT4051MT    | ACTIVE | SOIC         | D                  | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HCT4051M             | Samples |
| CD74HCT4051MTG4  | ACTIVE | SOIC         | D                  | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -55 to 125   | HCT4051M             | Samples |
| CD74HCT4052E     | ACTIVE | PDIP         | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type | -55 to 125   | CD74HCT4052E         | Samples |
| CD74HCT4052EE4   | ACTIVE | PDIP         | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU            | N / A for Pkg Type | -55 to 125   | CD74HCT4052E         | Samples |



| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish  | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|-------------------|--------------------|--------------|----------------------|---------|
| CD74HCT4052M     | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4052M             | Samples |
| CD74HCT4052M96   | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4052M             | Samples |
| CD74HCT4052M96G4 | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4052M             | Samples |
| CD74HCT4052ME4   | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4052M             | Samples |
| CD74HCT4052MG4   | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4052M             | Samples |
| CD74HCT4052MT    | ACTIVE | SOIC         | D                  | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4052M             | Samples |
| CD74HCT4053E     | ACTIVE | PDIP         | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU         | N / A for Pkg Type | -55 to 125   | CD74HCT4053E         | Samples |
| CD74HCT4053EE4   | ACTIVE | PDIP         | N                  | 16   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU         | N / A for Pkg Type | -55 to 125   | CD74HCT4053E         | Samples |
| CD74HCT4053M     | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4053M             | Samples |
| CD74HCT4053M96   | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4053M             | Samples |
| CD74HCT4053M96E4 | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4053M             | Samples |
| CD74HCT4053M96G4 | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4053M             | Samples |
| CD74HCT4053ME4   | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4053M             | Samples |
| CD74HCT4053MG4   | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4053M             | Samples |
| CD74HCT4053MT    | ACTIVE | SOIC         | D                  | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HCT4053M             | Samples |
| CD74HCT4053PWR   | ACTIVE | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN | Level-1-260C-UNLIM | -55 to 125   | HK4053               | Samples |
| CD74HCT4053PWRE4 | ACTIVE | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HK4053               | Samples |
| CD74HCT4053PWRG4 | ACTIVE | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -55 to 125   | HK4053               | Samples |



### PACKAGE OPTION ADDENDUM

22-Jul-2014

| Orderable Device | Status | Package Type | _       | Pins | _   | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|-----|----------------------------|------------------|--------------------|--------------|----------------|---------|
|                  | (1)    |              | Drawing |      | Qty | (2)                        | (6)              | (3)                |              | (4/5)          |         |
| CD74HCT4053PWT   | ACTIVE | TSSOP        | PW      | 16   | 250 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | HK4053         | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF CD54HC4051, CD54HC4052, CD54HC4053, CD54HC4051, CD74HC4051, CD74HC4052, CD74HC4053, CD74HC4051;





22-Jul-2014

- Catalog: CD74HC4051, CD74HC4052, CD74HC4053, CD74HCT4051
- Automotive: CD74HC4051-Q1, CD74HCT4051-Q1, CD74HC4051-Q1, CD74HCT4051-Q1
- Enhanced Product: CD74HC4051-EP, CD74HC4051-EP
- Military: CD54HC4051, CD54HC4052, CD54HC4053, CD54HCT4051

#### NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product Supports Defense, Aerospace and Medical Applications
- Military QML certified for Military and Defense Applications

**PACKAGE MATERIALS INFORMATION** 

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#### TAPE AND REEL INFORMATION



# TAPE DIMENSIONS KO P1 BO W Cavity AO

| A0 | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



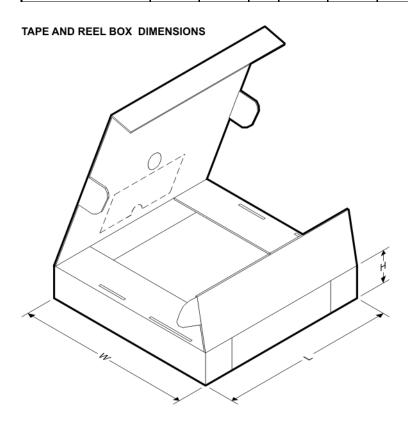
\*All dimensions are nominal

| Device          | Package<br>Type | Package<br>Drawing | Pins | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-----------------|-----------------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| CD74HC4051M96   | SOIC            | D                  | 16   | 2500 | 330.0                    | 16.8                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HC4051M96G3 | SOIC            | D                  | 16   | 2500 | 330.0                    | 16.8                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HC4051M96G4 | SOIC            | D                  | 16   | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HC4051PWR   | TSSOP           | PW                 | 16   | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HC4051PWR   | TSSOP           | PW                 | 16   | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HC4051PWRG4 | TSSOP           | PW                 | 16   | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HC4051PWT   | TSSOP           | PW                 | 16   | 250  | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HC4052M96   | SOIC            | D                  | 16   | 2500 | 330.0                    | 16.8                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HC4052M96G4 | SOIC            | D                  | 16   | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HC4052NSR   | SO              | NS                 | 16   | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| CD74HC4052PWR   | TSSOP           | PW                 | 16   | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HC4052PWR   | TSSOP           | PW                 | 16   | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HC4052PWRG4 | TSSOP           | PW                 | 16   | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HC4052PWT   | TSSOP           | PW                 | 16   | 250  | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HC4053M96   | SOIC            | D                  | 16   | 2500 | 330.0                    | 16.8                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HC4053M96G3 | SOIC            | D                  | 16   | 2500 | 330.0                    | 16.8                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HC4053M96G4 | SOIC            | D                  | 16   | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HC4053PWR   | TSSOP           | PW                 | 16   | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |

# **PACKAGE MATERIALS INFORMATION**

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| Device           | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| CD74HC4053PWR    | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HC4053PWRG4  | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HC4053PWT    | TSSOP           | PW                 | 16 | 250  | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HCT4051M96   | SOIC            | D                  | 16 | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HCT4052M96   | SOIC            | D                  | 16 | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HCT4053M96   | SOIC            | D                  | 16 | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HCT4053PWR   | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HCT4053PWR   | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HCT4053PWRG4 | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD74HCT4053PWT   | TSSOP           | PW                 | 16 | 250  | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74HC4051M96   | SOIC         | D               | 16   | 2500 | 364.0       | 364.0      | 27.0        |
| CD74HC4051M96G3 | SOIC         | D               | 16   | 2500 | 364.0       | 364.0      | 27.0        |
| CD74HC4051M96G4 | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |
| CD74HC4051PWR   | TSSOP        | PW              | 16   | 2000 | 364.0       | 364.0      | 27.0        |
| CD74HC4051PWR   | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| CD74HC4051PWRG4 | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| CD74HC4051PWT   | TSSOP        | PW              | 16   | 250  | 367.0       | 367.0      | 35.0        |



# **PACKAGE MATERIALS INFORMATION**

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| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74HC4052M96    | SOIC         | D               | 16   | 2500 | 364.0       | 364.0      | 27.0        |
| CD74HC4052M96G4  | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |
| CD74HC4052NSR    | SO           | NS              | 16   | 2000 | 367.0       | 367.0      | 38.0        |
| CD74HC4052PWR    | TSSOP        | PW              | 16   | 2000 | 364.0       | 364.0      | 27.0        |
| CD74HC4052PWR    | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| CD74HC4052PWRG4  | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| CD74HC4052PWT    | TSSOP        | PW              | 16   | 250  | 367.0       | 367.0      | 35.0        |
| CD74HC4053M96    | SOIC         | D               | 16   | 2500 | 364.0       | 364.0      | 27.0        |
| CD74HC4053M96G3  | SOIC         | D               | 16   | 2500 | 364.0       | 364.0      | 27.0        |
| CD74HC4053M96G4  | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |
| CD74HC4053PWR    | TSSOP        | PW              | 16   | 2000 | 364.0       | 364.0      | 27.0        |
| CD74HC4053PWR    | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| CD74HC4053PWRG4  | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| CD74HC4053PWT    | TSSOP        | PW              | 16   | 250  | 367.0       | 367.0      | 35.0        |
| CD74HCT4051M96   | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |
| CD74HCT4052M96   | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |
| CD74HCT4053M96   | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |
| CD74HCT4053PWR   | TSSOP        | PW              | 16   | 2000 | 364.0       | 364.0      | 27.0        |
| CD74HCT4053PWR   | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| CD74HCT4053PWRG4 | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| CD74HCT4053PWT   | TSSOP        | PW              | 16   | 250  | 367.0       | 367.0      | 35.0        |

## 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# D (R-PDS0-G16)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



# D (R-PDSO-G16)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PW (R-PDSO-G16)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153



# PW (R-PDSO-G16)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



#### **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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